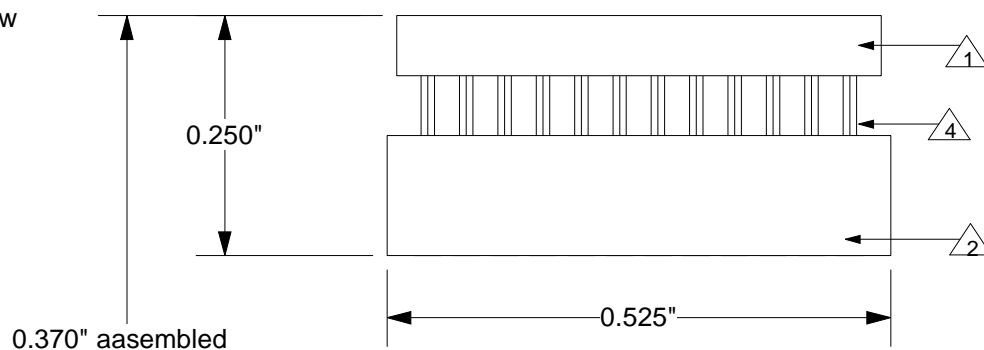
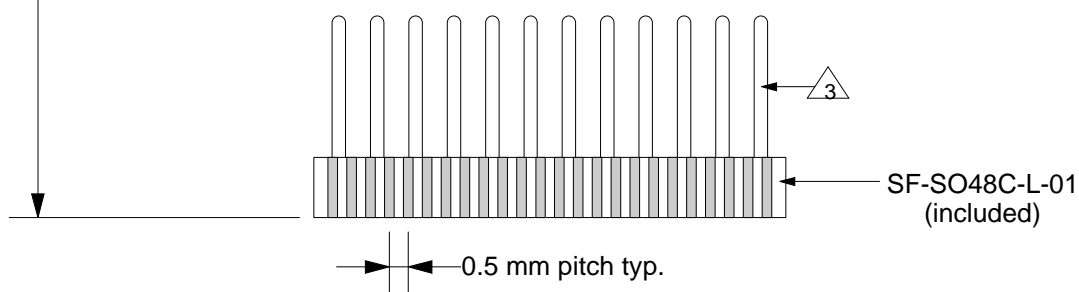


Top View



Side View




- 1 Substrate: 0.0625"±0.007" FR4/G10 or equivalent high temp material. 1/2 oz. Cu clad. SnPb plating
- 2 Substrate: 0.125"±0.007" FR4/G10 or equivalent high temp material. Non-clad

- 3 Pins: Material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Ni (min.).
- 4 Pins: shell material- Brass Alloy 360 1/2 hard; finish- 10µ" Au over 50µ" Ni (min.). Contact material- BeCu; finish 10µ" Au over 100µ" Ni (min.)

Description: TSOP Carrier Adaptor (CA)

48 position surface mount land pattern to 48 position surface mount foot (leadless). Additional surface mount feet, SF-SO48C-L-01, available separately.

All tolerances: ±0.005" (unless stated otherwise). Materials and specifications are subject to change without notice.

CA-SO48C-L-S-01 Drawing		Status: Released	Scale 5:1	Rev: B
	© 1999 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com		Drawing: E Smolentseva Date: 06/04/99	
			File: CA-SO48C-L-S-01 Dwg Modified:	